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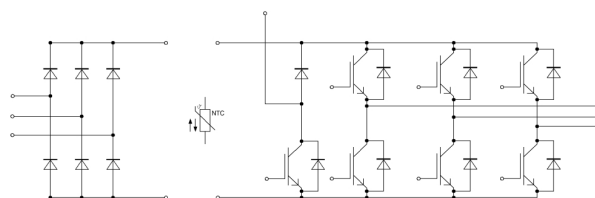
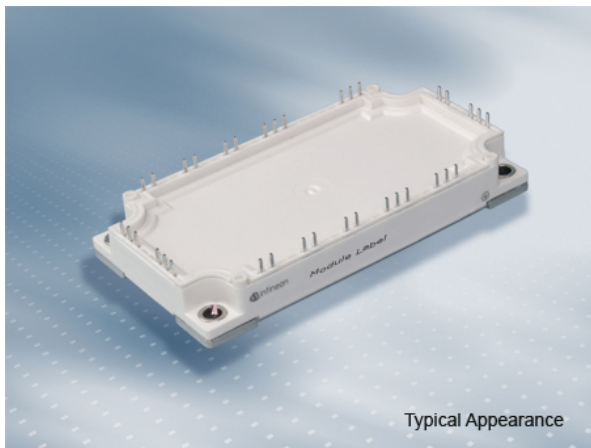
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EconoPIM™3 Modul mit Trench/Feldstopp IGBT4 und Emitter Controlled Diode und NTC  
EconoPIM™3 module with trench/fieldstop IGBT4 and Emitter Controlled Diode and NTC

**Vorläufige Daten / Preliminary Data**



$V_{CES} = 650V$   
 $I_{C\ nom} = 150A / I_{CRM} = 300A$

**Typische Anwendungen**

- Motorantriebe

**Elektrische Eigenschaften**

- Erhöhte Sperrspannungsfestigkeit auf 650V
- Hohe Kurzschlussrobustheit, selbstlimitierender Kurzschlussstrom
- Trench IGBT 4
- $T_{vj\ op} = 150^{\circ}C$
- $V_{CESat}$  mit positivem Temperaturkoeffizienten

**Mechanische Eigenschaften**

- Integrierter NTC Temperatur Sensor
- Kupferbodenplatte
- Lötverbindungstechnik
- Standardgehäuse

**Typical Applications**

- Motor Drives

**Electrical Features**

- Increased blocking voltage capability to 650V
- High Short Circuit Capability, Self Limiting Short Circuit Current
- Trench IGBT 4
- $T_{vj\ op} = 150^{\circ}C$
- $V_{CESat}$  with positive Temperature Coefficient

**Mechanical Features**

- Integrated NTC temperature sensor
- Copper Base Plate
- Solder Contact Technology
- Standard Housing

**Module Label Code**

Barcode Code 128



DMX - Code



**Content of the Code**

| Content of the Code        | Digit   |
|----------------------------|---------|
| Module Serial Number       | 1 - 5   |
| Module Material Number     | 6 - 11  |
| Production Order Number    | 12 - 19 |
| Datecode (Production Year) | 20 - 21 |
| Datecode (Production Week) | 22 - 23 |

|                 |                                 |                      |
|-----------------|---------------------------------|----------------------|
| prepared by: AS | date of publication: 2013-11-05 |                      |
| approved by: RS | revision: 2.0                   | UL approved (E83335) |



**Vorläufige Daten  
Preliminary Data**

**IGBT, Wechselrichter / IGBT, Inverter  
Höchstzulässige Werte / Maximum Rated Values**

|  |   |              |       |   |
|--|---|--------------|-------|---|
| Kollektor-Emitter-Sperrspannung<br>Collector-emitter voltage             | $T_{vj} = 25^{\circ}\text{C}$                                 | $V_{CES}$    | 650   | V |
| Kollektor-Dauergleichstrom<br>Continuous DC collector current            | $T_C = 55^{\circ}\text{C}, T_{vj\ max} = 175^{\circ}\text{C}$ | $I_{C\ nom}$ | 150   | A |
| Periodischer Kollektor-Spitzenstrom<br>Repetitive peak collector current | $t_P = 1\ \text{ms}$  | $I_{CRM}$    | 300   | A |
| Gesamt-Verlustleistung<br>Total power dissipation                        | $T_C = 25^{\circ}\text{C}, T_{vj\ max} = 175^{\circ}\text{C}$ | $P_{tot}$    | 430   | W |
| Gate-Emitter-Spitzenspannung<br>Gate-emitter peak voltage                |   | $V_{GES}$    | +/-20 | V |

**Charakteristische Werte / Characteristic Values**

|   |  |   | min.          | typ.                 | max. |             |   |
|---|--|---|---------------|----------------------|------|-------------|---|
| Kollektor-Emitter-Sättigungsspannung<br>Collector-emitter saturation voltage    | $I_C = 150\ \text{A}, V_{GE} = 15\ \text{V}$<br>$I_C = 150\ \text{A}, V_{GE} = 15\ \text{V}$<br>$I_C = 150\ \text{A}, V_{GE} = 15\ \text{V}$   | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$                   | $V_{CE\ sat}$ | 1,55<br>1,70<br>1,75 | 1,95 | V<br>V<br>V |   |
| Gate-Schwellenspannung<br>Gate threshold voltage                                | $I_C = 2,40\ \text{mA}, V_{CE} = V_{GE}, T_{vj} = 25^{\circ}\text{C}$  |   | $V_{GEth}$    | 5,0                  | 5,8  | 6,5         | V   |
| Gateladung<br>Gate charge   | $V_{GE} = -15\ \text{V} \dots +15\ \text{V}$   |   | $Q_G$         | 1,50                 |      |             | $\mu\text{C}$                                   |
| Interner Gatewiderstand<br>Internal gate resistor                               | $T_{vj} = 25^{\circ}\text{C}$  |   | $R_{Gint}$    | 2,0                  |      |             | $\Omega$  |
| Eingangskapazität<br>Input capacitance  | $f = 1\ \text{MHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25\ \text{V}, V_{GE} = 0\ \text{V}$  |   | $C_{ies}$     | 9,30                 |      |             | nF  |
| Rückwirkungskapazität<br>Reverse transfer capacitance                           | $f = 1\ \text{MHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25\ \text{V}, V_{GE} = 0\ \text{V}$  |   | $C_{res}$     | 0,285                |      |             | nF  |
| Kollektor-Emitter-Reststrom<br>Collector-emitter cut-off current                | $V_{CE} = 650\ \text{V}, V_{GE} = 0\ \text{V}, T_{vj} = 25^{\circ}\text{C}$  |   | $I_{CES}$     |                      |      | 1,0         | mA  |
| Gate-Emitter-Reststrom<br>Gate-emitter leakage current                          | $V_{CE} = 0\ \text{V}, V_{GE} = 20\ \text{V}, T_{vj} = 25^{\circ}\text{C}$   |   | $I_{GES}$     |                      |      | 400         | nA  |
| Einschaltverzögerungszeit, induktive Last<br>Turn-on delay time, inductive load | $I_C = 150\ \text{A}, V_{CE} = 300\ \text{V}$<br>$V_{GE} = \pm 15\ \text{V}$<br>$R_{Gon} = 3,3\ \Omega$  | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$                   | $t_{don}$     | 0,12<br>0,14<br>0,14 |      |             | $\mu\text{s}$<br>$\mu\text{s}$<br>$\mu\text{s}$ |
| Anstiegszeit, induktive Last<br>Rise time, inductive load                       | $I_C = 150\ \text{A}, V_{CE} = 300\ \text{V}$<br>$V_{GE} = \pm 15\ \text{V}$<br>$R_{Gon} = 3,3\ \Omega$  | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$                   | $t_r$         | 0,03<br>0,04<br>0,04 |      |             | $\mu\text{s}$<br>$\mu\text{s}$<br>$\mu\text{s}$ |
| Abschaltverzögerungszeit, induktive Last<br>Turn-off delay time, inductive load | $I_C = 150\ \text{A}, V_{CE} = 300\ \text{V}$<br>$V_{GE} = \pm 15\ \text{V}$<br>$R_{Goff} = 3,3\ \Omega$   | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$                   | $t_{doff}$    | 0,34<br>0,37<br>0,38 |      |             | $\mu\text{s}$<br>$\mu\text{s}$<br>$\mu\text{s}$ |
| Fallzeit, induktive Last<br>Fall time, inductive load                           | $I_C = 150\ \text{A}, V_{CE} = 300\ \text{V}$<br>$V_{GE} = \pm 15\ \text{V}$<br>$R_{Goff} = 3,3\ \Omega$   | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$                   | $t_f$         | 0,06<br>0,07<br>0,07 |      |             | $\mu\text{s}$<br>$\mu\text{s}$<br>$\mu\text{s}$ |
| Einschaltverlustenergie pro Puls<br>Turn-on energy loss per pulse               | $I_C = 150\ \text{A}, V_{CE} = 300\ \text{V}, L_S = 30\ \text{nH}$<br>$V_{GE} = \pm 15\ \text{V}, di/dt = 5400\ \text{A}/\mu\text{s} (T_{vj} = 150^{\circ}\text{C})$<br>$R_{Gon} = 3,3\ \Omega$  | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$                   | $E_{on}$      | 0,94<br>1,50<br>1,65 |      |             | mJ<br>mJ<br>mJ                                  |
| Abschaltverlustenergie pro Puls<br>Turn-off energy loss per pulse               | $I_C = 150\ \text{A}, V_{CE} = 300\ \text{V}, L_S = 30\ \text{nH}$<br>$V_{GE} = \pm 15\ \text{V}, du/dt = 3800\ \text{V}/\mu\text{s} (T_{vj} = 150^{\circ}\text{C})$<br>$R_{Goff} = 3,3\ \Omega$ | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$                   | $E_{off}$     | 5,75<br>7,40<br>7,85 |      |             | mJ<br>mJ<br>mJ                                  |
| Kurzschlußverhalten<br>SC data  | $V_{GE} \leq 15\ \text{V}, V_{CC} = 360\ \text{V}$<br>$V_{CEmax} = V_{CES} - L_{SCE} \cdot di/dt$  | $t_P \leq 10\ \mu\text{s}, T_{vj} = 25^{\circ}\text{C}$<br>$t_P \leq 10\ \mu\text{s}, T_{vj} = 150^{\circ}\text{C}$ | $I_{SC}$      | 720<br>570           |      |             | A<br>A  |
| Wärmewiderstand, Chip bis Gehäuse<br>Thermal resistance, junction to case       | pro IGBT / per IGBT  |   | $R_{thJC}$    |                      |      | 0,35        | K/W   |
| Wärmewiderstand, Gehäuse bis Kühlkörper<br>Thermal resistance, case to heatsink | pro IGBT / per IGBT<br>$\lambda_{Paste} = 1\ \text{W}/(\text{m}\cdot\text{K}) / \lambda_{grease} = 1\ \text{W}/(\text{m}\cdot\text{K})$  |   | $R_{thCH}$    |                      |      | 0,14        | K/W   |
| Temperatur im Schaltbetrieb<br>Temperature under switching conditions           |  |   | $T_{vj\ op}$  | -40                  |      | 150         | $^{\circ}\text{C}$                              |

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|-----------------|---------------------------------|
| prepared by: AS | date of publication: 2013-11-05 |
| approved by: RS | revision: 2.0                   |

**Vorläufige Daten  
Preliminary Data**

**Diode, Wechselrichter / Diode, Inverter**

**Höchstzulässige Werte / Maximum Rated Values**

|   |  |           |              |  |
|---|--|-----------|--------------|--|
| Periodische Spitzensperrspannung<br>Repetitive peak reverse voltage | $T_{vj} = 25^{\circ}\text{C}$  | $V_{RRM}$ | 650          | V  |
| Dauergleichstrom<br>Continuous DC forward current                   |  | $I_F$     | 150          | A  |
| Periodischer Spitzenstrom<br>Repetitive peak forward current        | $t_P = 1\text{ ms}$  | $I_{FRM}$ | 300          | A  |
| Grenzlastintegral<br>$I^2t$ - value                                 | $V_R = 0\text{ V}, t_P = 10\text{ ms}, T_{vj} = 125^{\circ}\text{C}$<br>$V_R = 0\text{ V}, t_P = 10\text{ ms}, T_{vj} = 150^{\circ}\text{C}$ | $I^2t$    | 2050<br>1950 | $\text{A}^2\text{s}$<br>$\text{A}^2\text{s}$ |

**Charakteristische Werte / Characteristic Values**

|   |  |   | min.               | typ.                 | max. |   |
|---|--|---|--------------------|----------------------|------|---|
| Durchlassspannung<br>Forward voltage  | $I_F = 150\text{ A}, V_{GE} = 0\text{ V}$<br>$I_F = 150\text{ A}, V_{GE} = 0\text{ V}$<br>$I_F = 150\text{ A}, V_{GE} = 0\text{ V}$        | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $V_F$              | 1,55<br>1,50<br>1,45 | 1,95 | V<br>V<br>V                                     |
| Rückstromspitze<br>Peak reverse recovery current                                | $I_F = 150\text{ A}, -di_F/dt = 5400\text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$<br>$V_R = 300\text{ V}$<br>$V_{GE} = -15\text{ V}$ | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $I_{RM}$           | 150<br>180<br>185    |      | A<br>A<br>A                                     |
| Sperrverzögerungsladung<br>Recovered charge                                     | $I_F = 150\text{ A}, -di_F/dt = 5400\text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$<br>$V_R = 300\text{ V}$<br>$V_{GE} = -15\text{ V}$ | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $Q_r$              | 7,00<br>13,0<br>15,0 |      | $\mu\text{C}$<br>$\mu\text{C}$<br>$\mu\text{C}$ |
| Abschaltenergie pro Puls<br>Reverse recovery energy                             | $I_F = 150\text{ A}, -di_F/dt = 5400\text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$<br>$V_R = 300\text{ V}$<br>$V_{GE} = -15\text{ V}$ | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $E_{rec}$          | 1,95<br>3,50<br>3,95 |      | mJ<br>mJ<br>mJ                                  |
| Wärmewiderstand, Chip bis Gehäuse<br>Thermal resistance, junction to case       | pro Diode / per diode  |   | $R_{thJC}$         |                      | 0,60 | K/W   |
| Wärmewiderstand, Gehäuse bis Kühlkörper<br>Thermal resistance, case to heatsink | pro Diode / per diode<br>$\lambda_{Paste} = 1\text{ W}/(\text{m}\cdot\text{K}) / \lambda_{grease} = 1\text{ W}/(\text{m}\cdot\text{K})$    |   | $R_{thCH}$         | 0,245                |      | K/W   |
| Temperatur im Schaltbetrieb<br>Temperature under switching conditions           |  |   | $T_{vj\text{ op}}$ | -40                  | 150  | $^{\circ}\text{C}$                              |

**Diode, Gleichrichter / Diode, Rectifier**

**Höchstzulässige Werte / Maximum Rated Values**

|   |   |             |              |  |
|---|---|-------------|--------------|--|
| Periodische Spitzensperrspannung<br>Repetitive peak reverse voltage                 | $T_{vj} = 25^{\circ}\text{C}$   | $V_{RRM}$   | 1600         | V  |
| Durchlassstrom Grenzeffektivwert pro Chip<br>Maximum RMS forward current per chip   | $T_C = 80^{\circ}\text{C}$  | $I_{FRMSM}$ | 150          | A  |
| Gleichrichter Ausgang Grenzeffektivstrom<br>Maximum RMS current at rectifier output | $T_C = 80^{\circ}\text{C}$  | $I_{RMSM}$  | 150          | A  |
| Stoßstrom Grenzwert<br>Surge forward current  | $t_p = 10\text{ ms}, T_{vj} = 25^{\circ}\text{C}$<br>$t_p = 10\text{ ms}, T_{vj} = 150^{\circ}\text{C}$ | $I_{FSM}$   | 1150<br>880  | A<br>A                                       |
| Grenzlastintegral<br>$I^2t$ - value   | $t_p = 10\text{ ms}, T_{vj} = 25^{\circ}\text{C}$<br>$t_p = 10\text{ ms}, T_{vj} = 150^{\circ}\text{C}$ | $I^2t$      | 6600<br>3850 | $\text{A}^2\text{s}$<br>$\text{A}^2\text{s}$ |

**Charakteristische Werte / Characteristic Values**

|   |   |                    | min. | typ.  | max. |                    |
|---|---|--------------------|------|-------|------|--------------------|
| Durchlassspannung<br>Forward voltage  | $T_{vj} = 150^{\circ}\text{C}, I_F = 150\text{ A}$  | $V_F$              |      | 1,10  |      | V                  |
| Sperrstrom<br>Reverse current   | $T_{vj} = 150^{\circ}\text{C}, V_R = 1600\text{ V}$   | $I_R$              |      | 1,00  |      | mA                 |
| Wärmewiderstand, Chip bis Gehäuse<br>Thermal resistance, junction to case       | pro Diode / per diode   | $R_{thJC}$         |      |       | 0,40 | K/W                |
| Wärmewiderstand, Gehäuse bis Kühlkörper<br>Thermal resistance, case to heatsink | pro Diode / per diode<br>$\lambda_{Paste} = 1\text{ W}/(\text{m}\cdot\text{K}) / \lambda_{grease} = 1\text{ W}/(\text{m}\cdot\text{K})$ | $R_{thCH}$         |      | 0,165 |      | K/W                |
| Temperatur im Schaltbetrieb<br>Temperature under switching conditions           |   | $T_{vj\text{ op}}$ | -40  |       | 150  | $^{\circ}\text{C}$ |

|                 |                                 |
|-----------------|---------------------------------|
| prepared by: AS | date of publication: 2013-11-05 |
| approved by: RS | revision: 2.0                   |

**Vorläufige Daten  
Preliminary Data**

**IGBT, Brems-Chopper / IGBT, Brake-Chopper  
Höchstzulässige Werte / Maximum Rated Values**

|  |   |                    |       |   |
|--|---|--------------------|-------|---|
| Kollektor-Emitter-Sperrspannung<br>Collector-emitter voltage             | $T_{vj} = 25^{\circ}\text{C}$                                       | $V_{CES}$          | 650   | V |
| Kollektor-Dauergleichstrom<br>Continuous DC collector current            | $T_C = 70^{\circ}\text{C}, T_{vj\text{ max}} = 175^{\circ}\text{C}$ | $I_{C\text{ nom}}$ | 100   | A |
| Periodischer Kollektor-Spitzenstrom<br>Repetitive peak collector current | $t_P = 1\text{ ms}$   | $I_{CRM}$          | 200   | A |
| Gesamt-Verlustleistung<br>Total power dissipation                        | $T_C = 25^{\circ}\text{C}, T_{vj\text{ max}} = 175^{\circ}\text{C}$ | $P_{tot}$          | 335   | W |
| Gate-Emitter-Spitzenspannung<br>Gate-emitter peak voltage                |   | $V_{GES}$          | +/-20 | V |

**Charakteristische Werte / Characteristic Values**

|   |   |   | min.                | typ.                 | max. |             |   |
|---|---|---|---------------------|----------------------|------|-------------|---|
| Kollektor-Emitter-Sättigungsspannung<br>Collector-emitter saturation voltage    | $I_C = 100\text{ A}, V_{GE} = 15\text{ V}$<br>$I_C = 100\text{ A}, V_{GE} = 15\text{ V}$<br>$I_C = 100\text{ A}, V_{GE} = 15\text{ V}$  | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$                   | $V_{CE\text{ sat}}$ | 1,55<br>1,70<br>1,75 | 1,95 | V<br>V<br>V |   |
| Gate-Schwellenspannung<br>Gate threshold voltage                                | $I_C = 1,60\text{ mA}, V_{CE} = V_{GE}, T_{vj} = 25^{\circ}\text{C}$  |   | $V_{GEth}$          | 5,0                  | 5,8  | 6,5         | V   |
| Gateladung<br>Gate charge   | $V_{GE} = -15\text{ V} \dots +15\text{ V}$  |   | $Q_G$               | 1,00                 |      |             | $\mu\text{C}$                                   |
| Interner Gatewiderstand<br>Internal gate resistor                               | $T_{vj} = 25^{\circ}\text{C}$   |   | $R_{Gint}$          | 2,0                  |      |             | $\Omega$  |
| Eingangskapazität<br>Input capacitance  | $f = 1\text{ MHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}$  |   | $C_{ies}$           | 6,20                 |      |             | nF  |
| Rückwirkungskapazität<br>Reverse transfer capacitance                           | $f = 1\text{ MHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}$  |   | $C_{res}$           | 0,19                 |      |             | nF  |
| Kollektor-Emitter-Reststrom<br>Collector-emitter cut-off current                | $V_{CE} = 650\text{ V}, V_{GE} = 0\text{ V}, T_{vj} = 25^{\circ}\text{C}$   |   | $I_{CES}$           |                      |      | 1,0         | mA  |
| Gate-Emitter-Reststrom<br>Gate-emitter leakage current                          | $V_{CE} = 0\text{ V}, V_{GE} = 20\text{ V}, T_{vj} = 25^{\circ}\text{C}$  |   | $I_{GES}$           |                      |      | 400         | nA  |
| Einschaltverzögerungszeit, induktive Last<br>Turn-on delay time, inductive load | $I_C = 100\text{ A}, V_{CE} = 300\text{ V}$<br>$V_{GE} = \pm 15\text{ V}$<br>$R_{Gon} = 3,3\ \Omega$  | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$                   | $t_{d\text{ on}}$   | 0,07<br>0,08<br>0,08 |      |             | $\mu\text{s}$<br>$\mu\text{s}$<br>$\mu\text{s}$ |
| Anstiegszeit, induktive Last<br>Rise time, inductive load                       | $I_C = 100\text{ A}, V_{CE} = 300\text{ V}$<br>$V_{GE} = \pm 15\text{ V}$<br>$R_{Gon} = 3,3\ \Omega$  | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$                   | $t_r$               | 0,02<br>0,02<br>0,02 |      |             | $\mu\text{s}$<br>$\mu\text{s}$<br>$\mu\text{s}$ |
| Abschaltverzögerungszeit, induktive Last<br>Turn-off delay time, inductive load | $I_C = 100\text{ A}, V_{CE} = 300\text{ V}$<br>$V_{GE} = \pm 15\text{ V}$<br>$R_{Goff} = 3,3\ \Omega$   | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$                   | $t_{d\text{ off}}$  | 0,26<br>0,29<br>0,30 |      |             | $\mu\text{s}$<br>$\mu\text{s}$<br>$\mu\text{s}$ |
| Fallzeit, induktive Last<br>Fall time, inductive load                           | $I_C = 100\text{ A}, V_{CE} = 300\text{ V}$<br>$V_{GE} = \pm 15\text{ V}$<br>$R_{Goff} = 3,3\ \Omega$   | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$                   | $t_f$               | 0,07<br>0,07<br>0,07 |      |             | $\mu\text{s}$<br>$\mu\text{s}$<br>$\mu\text{s}$ |
| Einschaltverlustenergie pro Puls<br>Turn-on energy loss per pulse               | $I_C = 100\text{ A}, V_{CE} = 300\text{ V}, L_S = 30\text{ nH}$<br>$V_{GE} = \pm 15\text{ V}, di/dt = 5100\text{ A}/\mu\text{s} (T_{vj} = 150^{\circ}\text{C})$<br>$R_{Gon} = 3,3\ \Omega$  | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$                   | $E_{on}$            | 0,33<br>0,77<br>0,88 |      |             | mJ<br>mJ<br>mJ                                  |
| Abschaltverlustenergie pro Puls<br>Turn-off energy loss per pulse               | $I_C = 100\text{ A}, V_{CE} = 300\text{ V}, L_S = 30\text{ nH}$<br>$V_{GE} = \pm 15\text{ V}, du/dt = 4000\text{ V}/\mu\text{s} (T_{vj} = 150^{\circ}\text{C})$<br>$R_{Goff} = 3,3\ \Omega$ | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$                   | $E_{off}$           | 3,50<br>4,70<br>4,90 |      |             | mJ<br>mJ<br>mJ                                  |
| Kurzschlußverhalten<br>SC data  | $V_{GE} \leq 15\text{ V}, V_{CC} = 360\text{ V}$<br>$V_{CE\text{ max}} = V_{CES} - L_{SCE} \cdot di/dt$   | $t_P \leq 10\ \mu\text{s}, T_{vj} = 25^{\circ}\text{C}$<br>$t_P \leq 10\ \mu\text{s}, T_{vj} = 150^{\circ}\text{C}$ | $I_{SC}$            | 480<br>380           |      |             | A<br>A  |
| Wärmewiderstand, Chip bis Gehäuse<br>Thermal resistance, junction to case       | pro IGBT / per IGBT   |   | $R_{thJC}$          |                      |      | 0,45        | K/W   |
| Wärmewiderstand, Gehäuse bis Kühlkörper<br>Thermal resistance, case to heatsink | pro IGBT / per IGBT<br>$\lambda_{\text{Paste}} = 1\text{ W}/(\text{m}\cdot\text{K}) / \lambda_{\text{grease}} = 1\text{ W}/(\text{m}\cdot\text{K})$   |   | $R_{thCH}$          |                      |      | 0,185       | K/W   |
| Temperatur im Schaltbetrieb<br>Temperature under switching conditions           |   |   | $T_{vj\text{ op}}$  | -40                  |      | 150         | $^{\circ}\text{C}$                              |

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**Vorläufige Daten  
Preliminary Data**

**Diode, Brems-Chopper / Diode, Brake-Chopper  
Höchstzulässige Werte / Maximum Rated Values**

|   |  |           |     |                      |
|---|--|-----------|-----|----------------------|
| Periodische Spitzensperrspannung<br>Repetitive peak reverse voltage | $T_{vj} = 25^{\circ}\text{C}$  | $V_{RRM}$ | 650 | V                    |
| Dauergleichstrom<br>Continuous DC forward current                   |  | $I_F$     | 50  | A                    |
| Periodischer Spitzenstrom<br>Repetitive peak forward current        | $t_P = 1\text{ ms}$  | $I_{FRM}$ | 100 | A                    |
| Grenzlastintegral<br>$I^2t$ - value                                 | $V_R = 0\text{ V}, t_P = 10\text{ ms}, T_{vj} = 125^{\circ}\text{C}$ | $I^2t$    | 330 | $\text{A}^2\text{s}$ |
|   | $V_R = 0\text{ V}, t_P = 10\text{ ms}, T_{vj} = 150^{\circ}\text{C}$ |           | 300 | $\text{A}^2\text{s}$ |

**Charakteristische Werte / Characteristic Values**

|   |   |                                | min. | typ. | max. |                    |
|---|---|--------------------------------|------|------|------|--------------------|
| Durchlassspannung<br>Forward voltage  | $I_F = 50\text{ A}, V_{GE} = 0\text{ V}$  | $T_{vj} = 25^{\circ}\text{C}$  |      | 1,55 | 1,95 | V                  |
|   | $I_F = 50\text{ A}, V_{GE} = 0\text{ V}$  | $T_{vj} = 125^{\circ}\text{C}$ |      | 1,50 |      | V                  |
|   | $I_F = 50\text{ A}, V_{GE} = 0\text{ V}$  | $T_{vj} = 150^{\circ}\text{C}$ |      | 1,45 |      | V                  |
| Rückstromspitze<br>Peak reverse recovery current                                | $I_F = 50\text{ A}, -di_F/dt = 2800\text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$<br>$V_R = 300\text{ V}$                          | $T_{vj} = 25^{\circ}\text{C}$  |      | 69,0 |      | A                  |
|   |   | $T_{vj} = 125^{\circ}\text{C}$ |      | 76,0 |      | A                  |
|   |   | $T_{vj} = 150^{\circ}\text{C}$ |      | 80,0 |      | A                  |
| Sperrverzögerungsladung<br>Recovered charge                                     | $I_F = 50\text{ A}, -di_F/dt = 2800\text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$<br>$V_R = 300\text{ V}$                          | $T_{vj} = 25^{\circ}\text{C}$  |      | 1,90 |      | $\mu\text{C}$      |
|   |   | $T_{vj} = 125^{\circ}\text{C}$ |      | 3,40 |      | $\mu\text{C}$      |
|   |   | $T_{vj} = 150^{\circ}\text{C}$ |      | 3,95 |      | $\mu\text{C}$      |
| Abschaltenergie pro Puls<br>Reverse recovery energy                             | $I_F = 50\text{ A}, -di_F/dt = 2800\text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$<br>$V_R = 300\text{ V}$                          | $T_{vj} = 25^{\circ}\text{C}$  |      | 0,60 |      | mJ                 |
|   |   | $T_{vj} = 125^{\circ}\text{C}$ |      | 0,95 |      | mJ                 |
|   |   | $T_{vj} = 150^{\circ}\text{C}$ |      | 1,10 |      | mJ                 |
| Wärmewiderstand, Chip bis Gehäuse<br>Thermal resistance, junction to case       | pro Diode / per diode   | $R_{thJC}$                     |      |      | 1,20 | K/W                |
| Wärmewiderstand, Gehäuse bis Kühlkörper<br>Thermal resistance, case to heatsink | pro Diode / per diode<br>$\lambda_{Paste} = 1\text{ W}/(\text{m}\cdot\text{K}) / \lambda_{grease} = 1\text{ W}/(\text{m}\cdot\text{K})$ | $R_{thCH}$                     |      | 0,49 |      | K/W                |
| Temperatur im Schaltbetrieb<br>Temperature under switching conditions           |   | $T_{vj\text{ op}}$             | -40  |      | 150  | $^{\circ}\text{C}$ |

**NTC-Widerstand / NTC-Thermistor**

**Charakteristische Werte / Characteristic Values**

|  |   |              | min. | typ. | max. |                  |
|--|---|--------------|------|------|------|------------------|
| Nennwiderstand<br>Rated resistance       | $T_C = 25^{\circ}\text{C}$                                    | $R_{25}$     |      | 5,00 |      | $\text{k}\Omega$ |
| Abweichung von R100<br>Deviation of R100 | $T_C = 100^{\circ}\text{C}, R_{100} = 493\ \Omega$            | $\Delta R/R$ | -5   |      | 5    | %                |
| Verlustleistung<br>Power dissipation     | $T_C = 25^{\circ}\text{C}$                                    | $P_{25}$     |      |      | 20,0 | mW               |
| B-Wert<br>B-value                        | $R_2 = R_{25} \exp [B_{25/50}(1/T_2 - 1/(298,15\text{ K}))]$  | $B_{25/50}$  |      | 3375 |      | K                |
| B-Wert<br>B-value                        | $R_2 = R_{25} \exp [B_{25/80}(1/T_2 - 1/(298,15\text{ K}))]$  | $B_{25/80}$  |      | 3411 |      | K                |
| B-Wert<br>B-value                        | $R_2 = R_{25} \exp [B_{25/100}(1/T_2 - 1/(298,15\text{ K}))]$ | $B_{25/100}$ |      | 3433 |      | K                |

Angaben gemäß gültiger Application Note.  
Specification according to the valid application note.

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**Vorläufige Daten  
Preliminary Data**

**Modul / Module**

|  |  |  |                                |            |          |
|--|--|--|--------------------------------|------------|----------|
| Isolations-Prüfspannung<br>Isolation test voltage                                      | RMS, f = 50 Hz, t = 1 min.   | V <sub>ISOL</sub>                            | 2,5                            |            | kV       |
| Material Modulgrundplatte<br>Material of module baseplate                              |  |  | Cu                             |            |          |
| Innere Isolation<br>Internal isolation   | Basisisolation (Schutzklasse 1, EN61140)<br>basic insulation (class 1, IEC 61140)  |  | Al <sub>2</sub> O <sub>3</sub> |            |          |
| Kriechstrecke<br>Creepage distance   | Kontakt - Kühlkörper / terminal to heatsink<br>Kontakt - Kontakt / terminal to terminal  |  | 10,0                           |            | mm       |
| Luftstrecke<br>Clearance   | Kontakt - Kühlkörper / terminal to heatsink<br>Kontakt - Kontakt / terminal to terminal  |  | 7,5                            |            | mm       |
| Vergleichszahl der Kriechwegbildung<br>Comperative tracking index                      |  | CTI  | > 200                          |            |          |
|  |  |  | min.    typ.    max.           |            |          |
| Wärmewiderstand, Gehäuse bis Kühlkörper<br>Thermal resistance, case to heatsink        | pro Modul / per module<br>$\lambda_{\text{Paste}} = 1 \text{ W/(m}\cdot\text{K)} / \lambda_{\text{grease}} = 1 \text{ W/(m}\cdot\text{K)}$ | R <sub>thCH</sub>                            | 0,009                          |            | K/W      |
| Modulstreuintduktivität<br>Stray inductance module                                     |  | L <sub>sCE</sub>                             | 40                             |            | nH       |
| Modulleitungswiderstand, Anschlüsse - Chip<br>Module lead resistance, terminals - chip | T <sub>c</sub> = 25°C, pro Schalter / per switch   | R <sub>CC'+EE'</sub><br>R <sub>AA'+CC'</sub> | 4,00<br>2,00                   |            | mΩ       |
| Höchstzulässige Sperrschichttemperatur<br>Maximum junction temperature                 | Wechselrichter, Brems-Chopper / inverter, brake-chopper<br>Gleichrichter / rectifier   | T <sub>vj max</sub>                          |                                | 175<br>150 | °C<br>°C |
| Temperatur im Schaltbetrieb<br>Temperature under switching conditions                  | Wechselrichter, Brems-Chopper / inverter, brake-chopper<br>Gleichrichter / rectifier   | T <sub>vj op</sub>                           | -40<br>-40                     | 150<br>150 | °C<br>°C |
| Lagertemperatur<br>Storage temperature   |  | T <sub>stg</sub>                             | -40                            | 125        | °C       |
| Anzugsdrehmoment f. Modulmontage<br>Mounting torque for modul mounting                 | Schraube M5 - Montage gem. gültiger Applikationsschrift<br>Screw M5 - Mounting according to valid application note                         | M  | 3,00                           | -          | 6,00 Nm  |
| Gewicht<br>Weight  |  | G  | 300                            |            | g        |

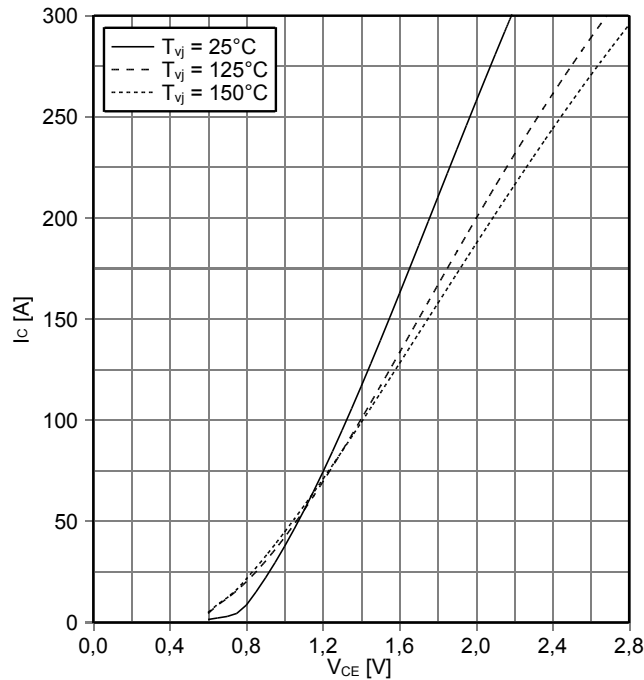
bei Betrieb mit V<sub>ge</sub> = 0V/+15V empfehlen wir einen R<sub>gon,min</sub> von 24 Ohm und eine R<sub>goff,min</sub> von 24 Ohm (siehe AN 2006-01)  
for operation with V<sub>ge</sub>= 0V/+15V we recommend a R<sub>gon,min</sub> of 24 ohms and a R<sub>goff,min</sub> of 24 ohms (see AN 2006-01)

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**Vorläufige Daten**  
**Preliminary Data**

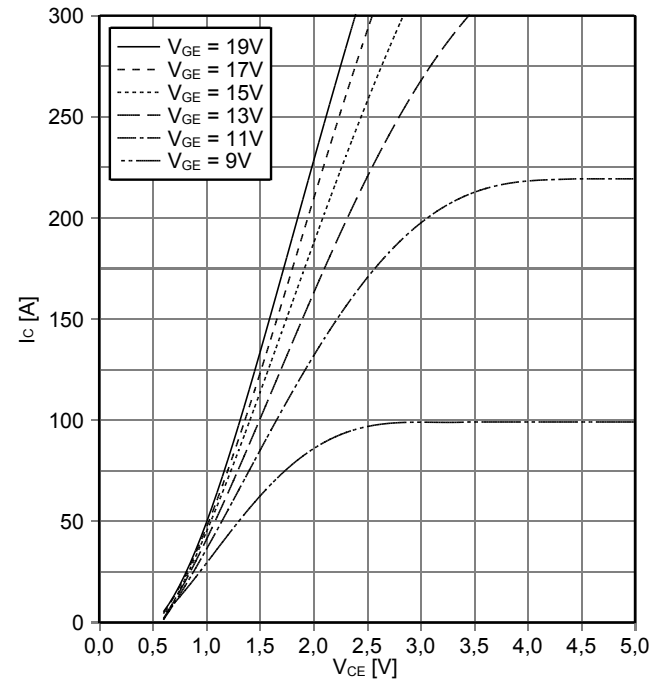
**Ausgangskennlinie IGBT, Wechselrichter (typisch)**  
**output characteristic IGBT, Inverter (typical)**

$I_C = f(V_{CE})$   
 $V_{GE} = 15\text{ V}$



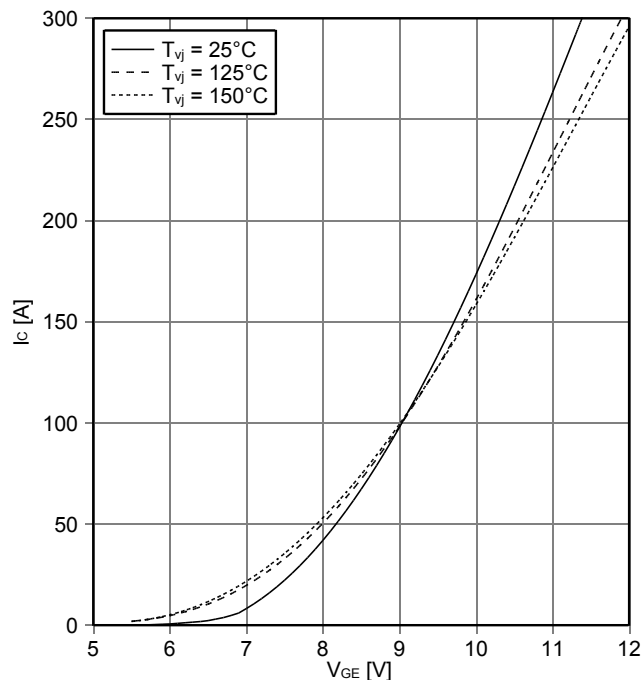
**Ausgangskennlinienfeld IGBT, Wechselrichter (typisch)**  
**output characteristic IGBT, Inverter (typical)**

$I_C = f(V_{CE})$   
 $T_{vj} = 150^\circ\text{C}$



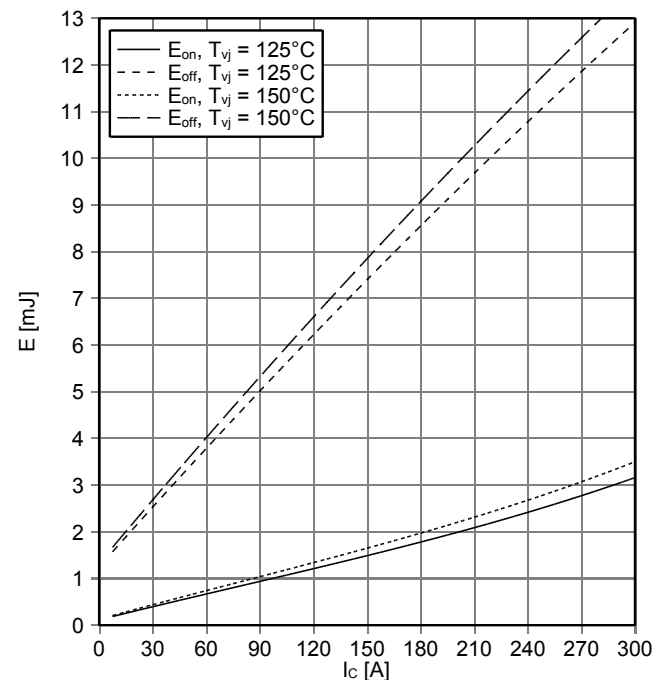
**Übertragungscharakteristik IGBT, Wechselrichter (typisch)**  
**transfer characteristic IGBT, Inverter (typical)**

$I_C = f(V_{GE})$   
 $V_{CE} = 20\text{ V}$



**Schaltverluste IGBT, Wechselrichter (typisch)**  
**switching losses IGBT, Inverter (typical)**

$E_{on} = f(I_C), E_{off} = f(I_C)$   
 $V_{GE} = \pm 15\text{ V}, R_{Gon} = 3.3\ \Omega, R_{Goff} = 3.3\ \Omega, V_{CE} = 300\text{ V}$



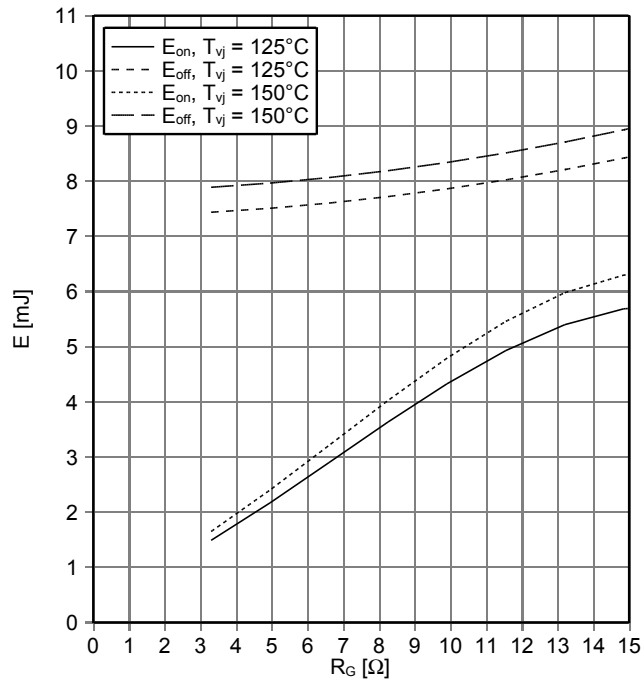
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**Vorläufige Daten**  
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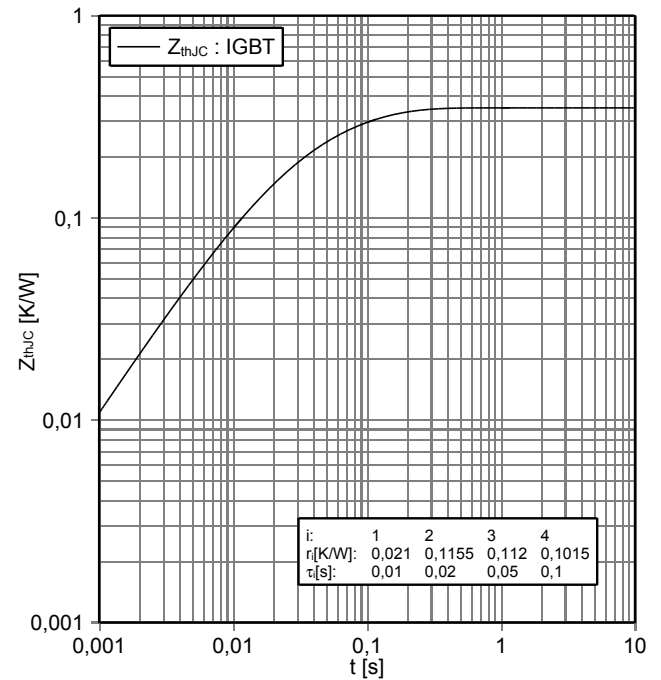
**Schaltverluste IGBT, Wechselrichter (typisch)**  
**switching losses IGBT, Inverter (typical)**

$E_{on} = f(R_G), E_{off} = f(R_G)$   
 $V_{GE} = \pm 15\text{ V}, I_C = 150\text{ A}, V_{CE} = 300\text{ V}$



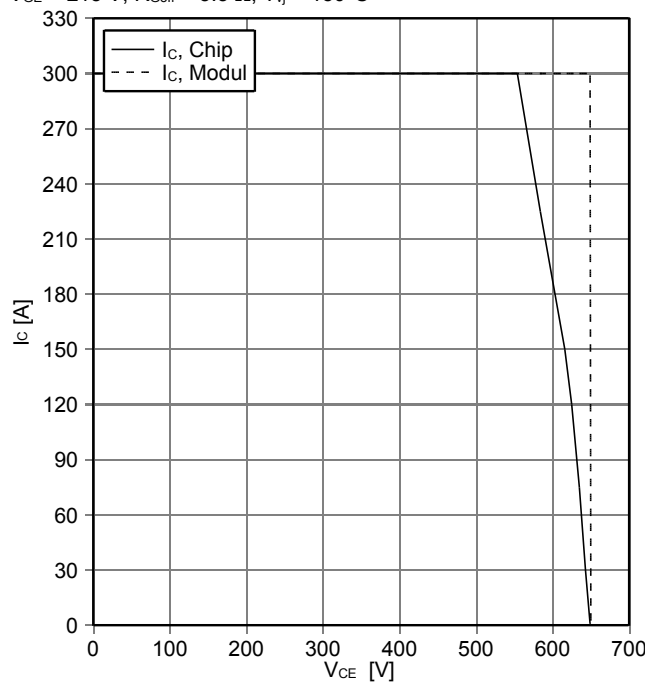
**Transienter Wärmewiderstand IGBT, Wechselrichter**  
**transient thermal impedance IGBT, Inverter**

$Z_{thJC} = f(t)$



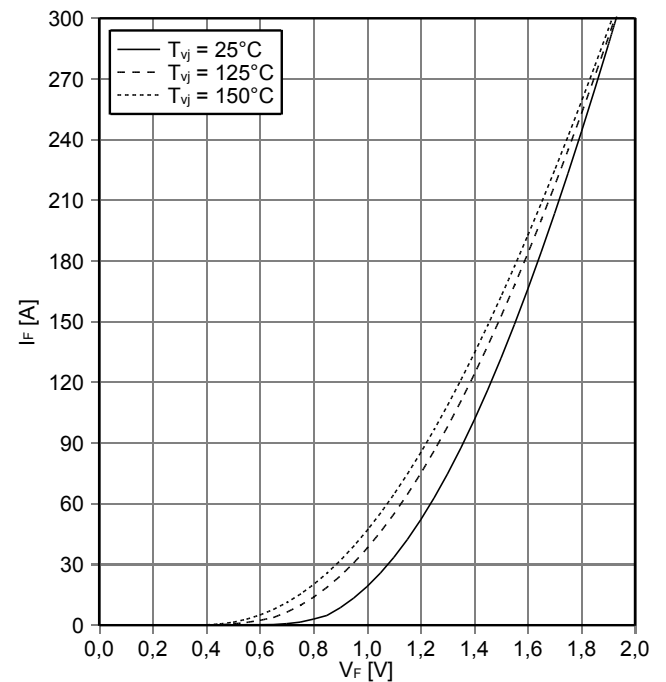
**Sicherer Rückwärts-Arbeitsbereich IGBT, Wechselrichter (RBSOA)**  
**reverse bias safe operating area IGBT, Inverter (RBSOA)**

$I_C = f(V_{CE})$   
 $V_{GE} = \pm 15\text{ V}, R_{Goff} = 3.3\ \Omega, T_{vj} = 150^\circ\text{C}$



**Durchlasskennlinie der Diode, Wechselrichter (typisch)**  
**forward characteristic of Diode, Inverter (typical)**

$I_F = f(V_F)$

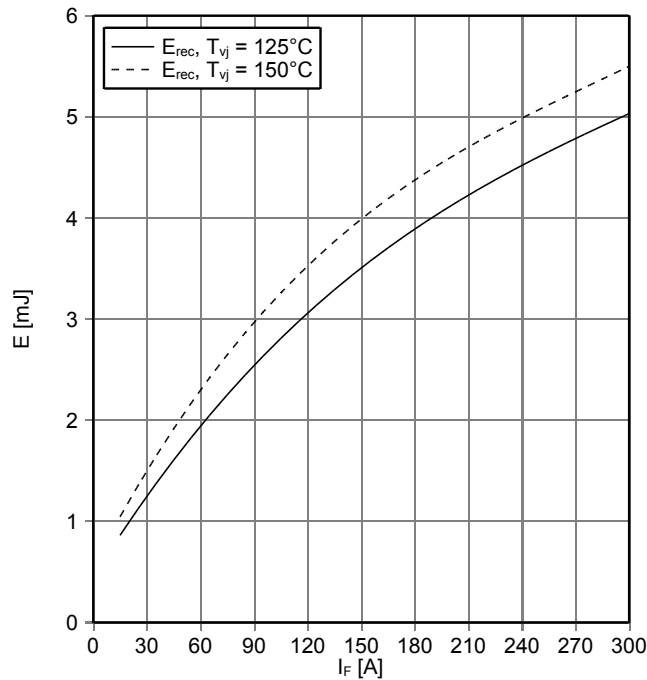


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**Vorläufige Daten  
Preliminary Data**

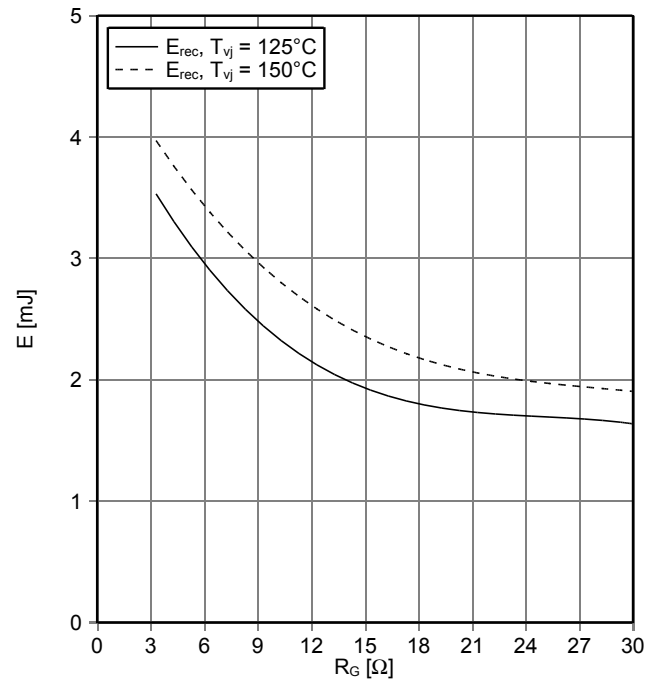
**Schaltverluste Diode, Wechselrichter (typisch)  
switching losses Diode, Inverter (typical)**

$E_{rec} = f(I_F)$   
 $R_{Gon} = 3.3 \Omega, V_{CE} = 300 V$



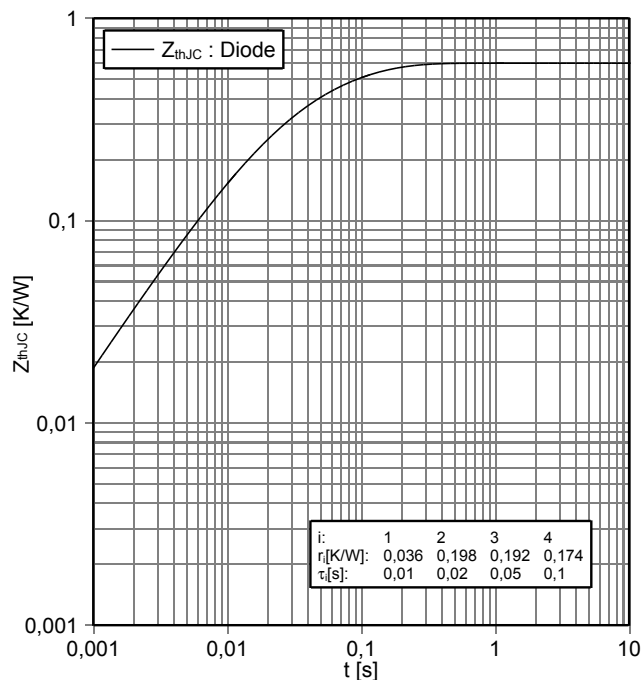
**Schaltverluste Diode, Wechselrichter (typisch)  
switching losses Diode, Inverter (typical)**

$E_{rec} = f(R_G)$   
 $I_F = 150 A, V_{CE} = 300 V$



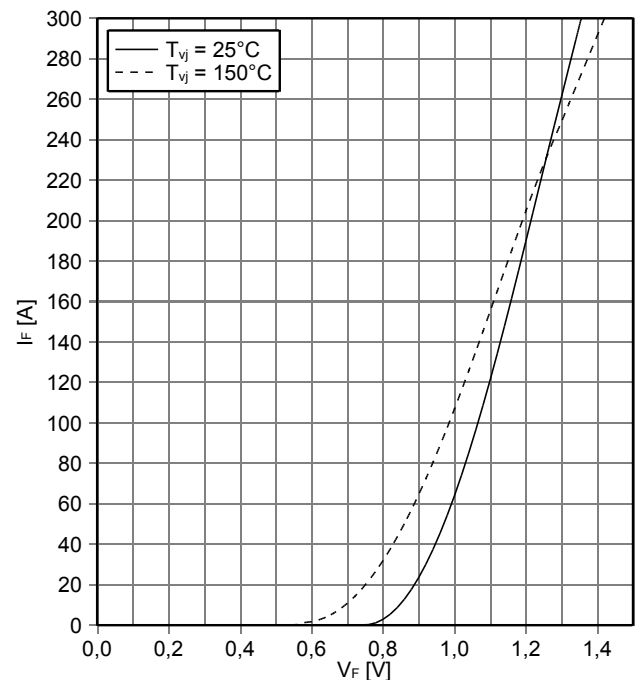
**Transienter Wärmewiderstand Diode, Wechselrichter  
transient thermal impedance Diode, Inverter**

$Z_{thJC} = f(t)$



**Durchlasskennlinie der Diode, Gleichrichter (typisch)  
forward characteristic of Diode, Rectifier (typical)**

$I_F = f(V_F)$

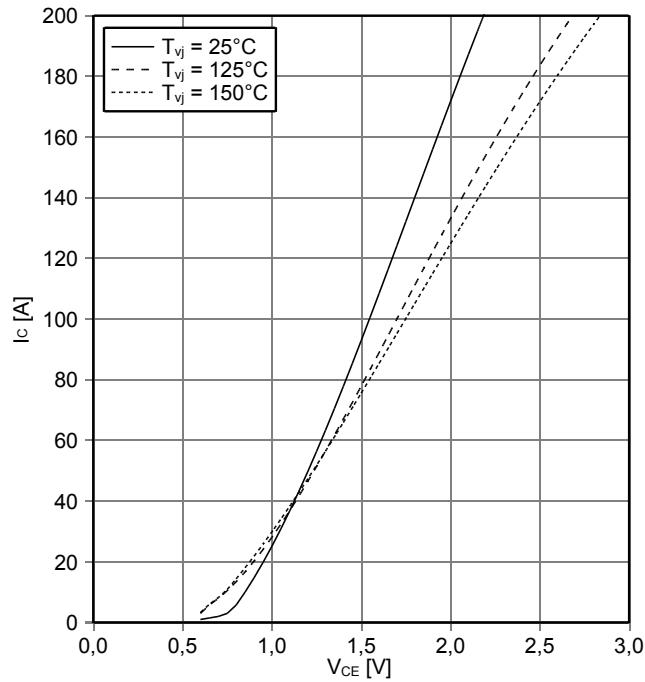


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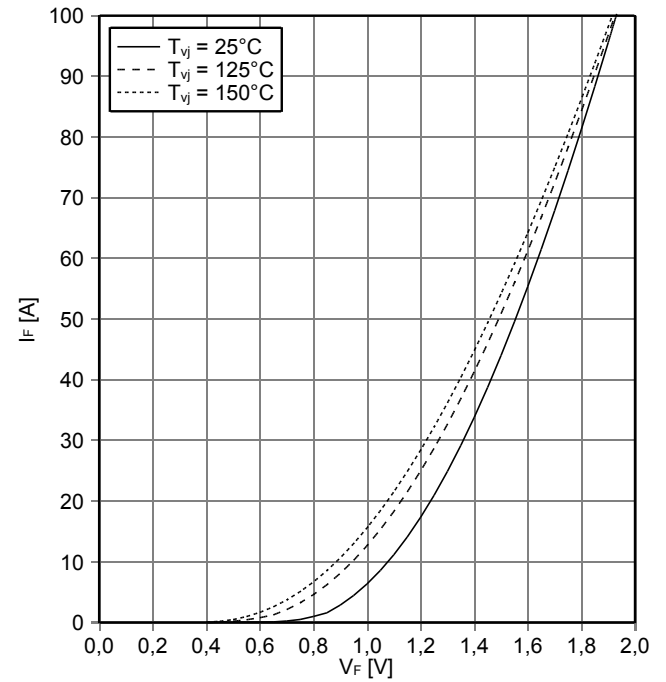
**Ausgangskennlinie IGBT, Brems-Chopper (typisch)**  
**output characteristic IGBT, Brake-Chopper (typical)**

$I_C = f(V_{CE})$   
 $V_{GE} = 15\text{ V}$



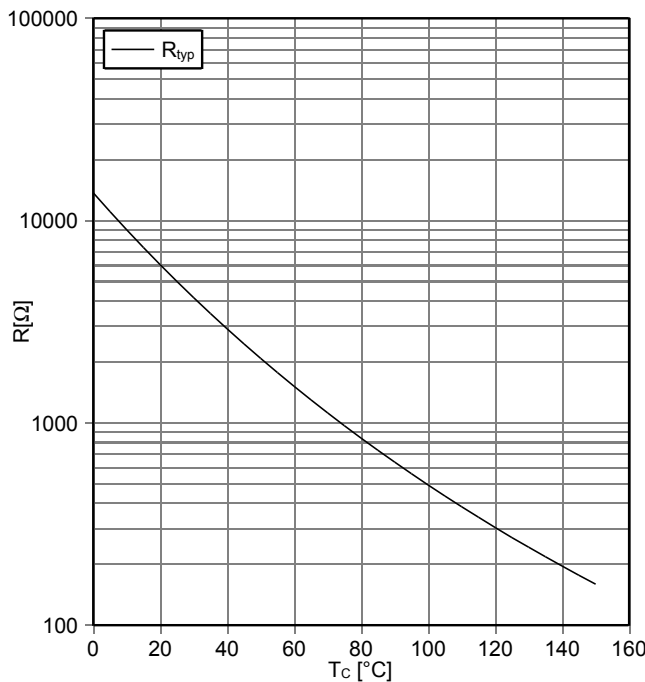
**Durchlasskennlinie der Diode, Brems-Chopper (typisch)**  
**forward characteristic of Diode, Brake-Chopper (typical)**

$I_F = f(V_F)$



**NTC-Widerstand-Temperaturkennlinie (typisch)**  
**NTC-Thermistor-temperature characteristic (typical)**

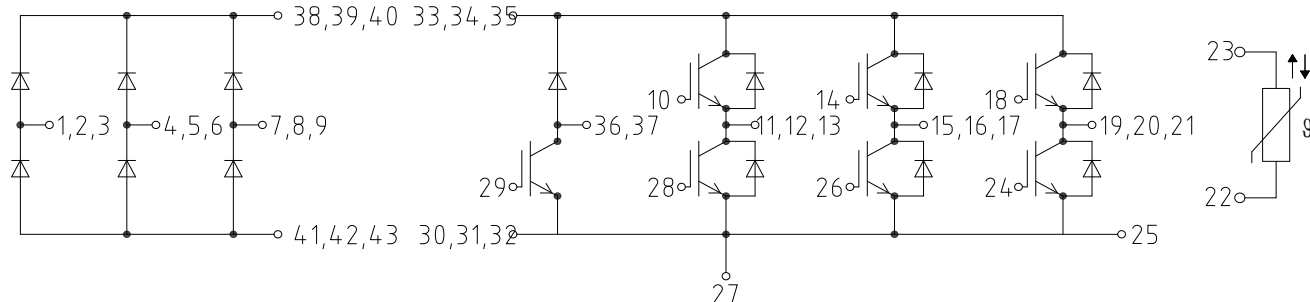
$R = f(T)$



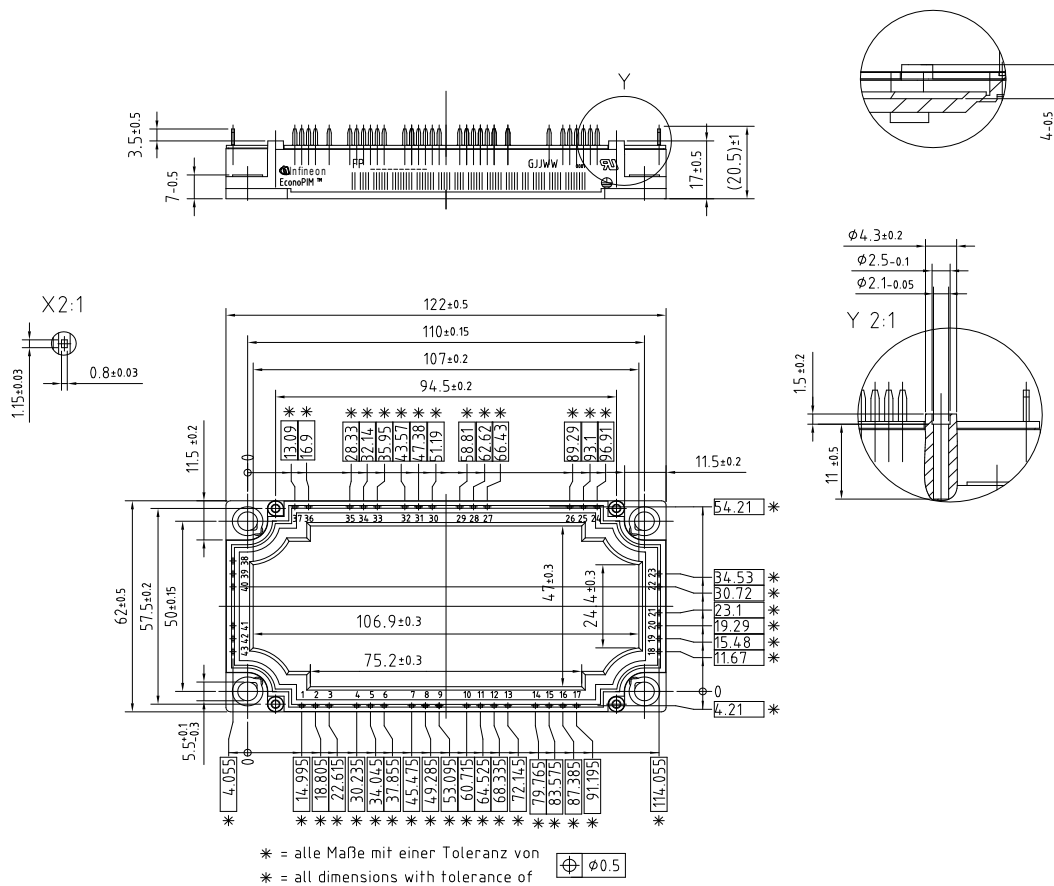
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**Vorläufige Daten**  
**Preliminary Data**

**Schaltplan / circuit\_diagram\_headline**



**Gehäuseabmessungen / package outlines**



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**Vorläufige Daten  
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- to perform joint Risk and Quality Assessments;
- the conclusion of Quality Agreements;
- to establish joint measures of an ongoing product survey, and that we may make delivery depended on the realization of any such measures.

If and to the extent necessary, please forward equivalent notices to your customers.

Changes of this product data sheet are reserved.

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